Exhibit 11



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(12) United States Patent Leedy

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(54) THREE DIMENSIONAL STRUCTURE MEMORY

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(US)

(*) Notice: Subject to any disclaimer, the term of this

patent is extended or adjusted under 35

U.S.C. 154(b) by 1023 days.

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(51) **Int. Cl.** *H01L 23/48*

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(52) U.S. Cl.

H01L 2224/8384 (2013.01) USPC **257/777**; 257/778; 257/685; 257/686;

365/200; 365/201; 438/977

(58) Field of Classification Search

USPC 257/777, 778, 685, 686; 365/200, 201, 365/230.6

See application file for complete search history.

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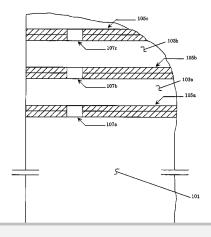
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Primary Examiner — Telly Green (74) Attorney, Agent, or Firm — Useful Arts IP

(57) ABSTRACT

A Three-Dimensional Structure (3DS) Memory allows for physical separation of the memory circuits and the control logic circuit onto different layers such that each layer may be separately optimized. One control logic circuit suffices for several memory circuits, reducing cost. Fabrication of 3DS memory involves thinning of the memory circuit to less than 50 µm in thickness and bonding the circuit to a circuit stack while still in wafer substrate form. Fine-grain high density inter-layer vertical bus connections are used. The 3DS memory manufacturing method enables several performance and physical size efficiencies, and is implemented with established semiconductor processing techniques.

95 Claims, 9 Drawing Sheets





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